

LDS-1310-DFB-2.5G-20S-TEC

Preliminary

OVERVIEW

LDS-1310-DFB-2.5G-20S-TEC is the laser diode with an integrated TEC (Thermo-Electric Cooler) coupled to an optical fiber and packaged into a hermetic case. The special feature of the LDS technology is the increased thermal stability of optical power.

MAIN FEATURES

- Wavelength: 1310 nm
- Cavity type: DFB
- Linewidth: < 1 MHz
- Data rate up to 2.5 Gbps
- Optical power: up to 20 mW in CW mode
- Package types: coaxial with bracket
- Built-in monitor photodiode
- Built-in TEC and thermistor

APPLICATIONS

- Laser systems

ORDERING INFORMATION

LDS-1310-DFB-2.5G-20S-TEC-X-27-X-X-X-X

Case type

B: compact coaxial with double-sided bracket
 Other type on request

Fiber type

SMT: SM, [Corning Titania-Clad](#), furcation tubing Ø0.9 mm, ultrasmall bending radius 2.5 mm
SM1: SM, G.657.A1, [Corning SMF-28 Ultra](#), furcation tubing Ø0.9 mm or **BSM1** Ø0.25mm
SM3: SM, G.657.B3, [Corning ClearCurve ZBL](#), furcation tubing Ø0.9 mm or **BSM3** Ø0.25mm
MM5: MM, [50/125. OM2](#), furcation tubing Ø0.9 mm
MM6: MM, [62.5/125. OM1](#), furcation tubing Ø0.9 mm
 Other type on request

Connector type

FA: FC/APC (SM1, SM3, SMT) **FU:** FC/UPC (SM1, SM3, SMT, MM5, MM6)
SA: SC/APC (SM1) **SU:** SC/UPC (SM1)
N: no connector
 Other type: on request

Test measurements

CW: CW mode (electro-optical parameters at T=25+/-5 C and spectrum)

Fiber length

0.5: 500+/-50 mm
1.0: 1000+/-100 mm
 Other length on request

Version 25.1

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ABSOLUTE MAXIMUM RATINGS

Parameter		Value	Unit	Conditions
Laser diode forward current	I_{FL}	100	mA	CW, T = 25 °C, Tst = 45 °C
Laser diode reverse voltage	V_{RL}	2	V	
Photodiode reverse voltage	V_{RP}	15	V	
Photodiode forward current	I_{FP}	5	mA	
Operating temperature*	T_{OP}	-15 - +60	°C	Ambient (heat sink)
Storage temperature	T_{stg}	-40 - +85	°C	
Soldering temperature	T_{sold}	260	°C	Max. 5 seconds
TEC Voltage	V_{TEC}	1.1	V	
TEC Current	I_{TEC}	1.2	A	

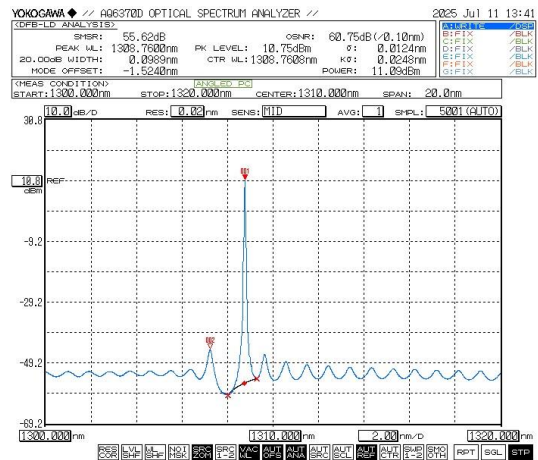
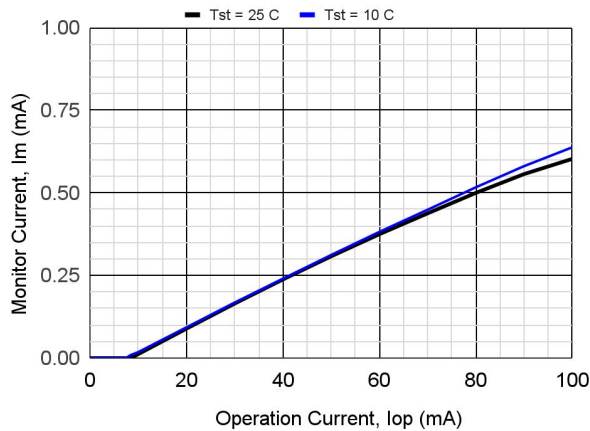
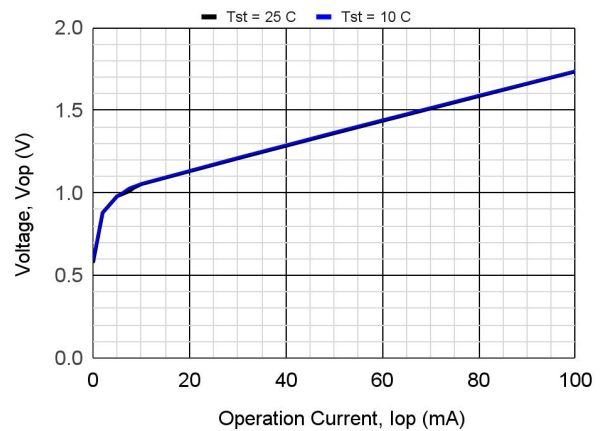
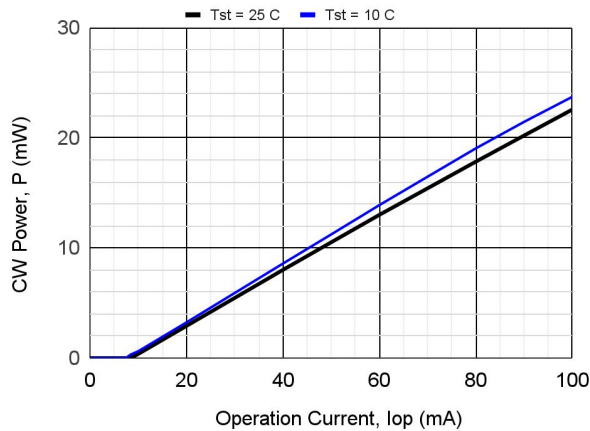
*Operating temperature is defined for internal temperature stabilization at Tst = 45°C that corresponds to thermistor resistance Rt = 4.4 kOhm.

It is necessary to ensure sufficient heat dissipation so that the module's maximum operating temperature is not exceeded.

ELECTRICAL-OPTICAL CHARACTERISTICS (T = 25 °C, Tst = 25 °C)

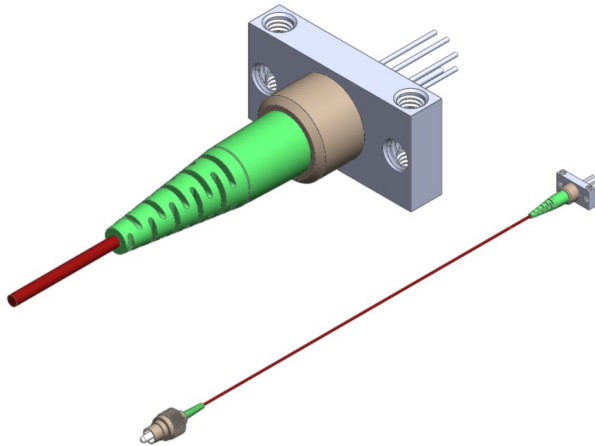
Parameter		MIN	TYP	MAX	Unit	Conditions
Optical power (CW)	P_{CW}	20			mW	CW, I_{op} = 100 mA, SM1,
Wavelength	λ	1308	1310	1312	nm	CW, I_{op} = 100 mA
Spectral width	$\Delta\lambda$		0.1		nm	CW, I_{op} = 100 mA, -20 dB, OSA
Spectral width	Δf			1	MHz	CW, I_{op} = 100 mA, -3 dB, delayed self-heterodyne method
Wavelength-temperature coeff.	$d\lambda/dT$		0.06		nm/°C	
Side-mode suppression ratio	SMSR	45			dB	CW, I_{op} = 100 mA
Threshold current	I_{th}		8	12	mA	CW
Slope efficiency	S_e	0.28	0.35		W/A	CW, SM1
Operating voltage	V_{op}		1.7	2.0	V	CW, I_{op} = 100 mA
Monitoring output current (PD)	I_m	0.01	0.5	5	mA	CW, I_{op} = 100 mA, V_{rd} = 5V
Thermistor resistance	R_{th}	9.5	10.0	10.5	kOhm	Tst = 25 °C
Thermistor B Constant	B	3800	3900	4000	K	

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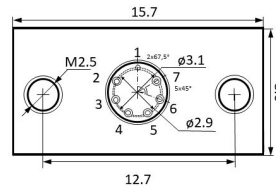


LDS-1310-DFB-2.5G-20S-TEC

PACKAGE B



BACK VIEW



PINOUT #27

1. LD (-)/Gnd/Rth
2. LD (+)
3. PD (+)
4. TEC (-)
5. TEC (+)
6. PD (-)
7. Rth

Download more
information



Drawing



3D model



Application Notes

LDS-1310-DFB-2.5G-20S-TEC

Characteristics, data, materials and structures specified in this datasheet are subject to change without notice. Please refer to the latest specification before use of the products.

Safety and handling cautions

1. Avoid smashing and burning of the module. Avoid storing and using the module in conditions where water, organic solvents or aggressive acids or bases may contact the module or where there is a possibility of exposure to corrosive gases, explosive gases, dust, salinity or other harsh conditions. The module should be disposed as special industrial waste.
2. Exceeding absolute maximum ratings even for a short time can cause permanent damage of the module.
3. The module is sensitive to and can be broken by ESD (static electricity).

Conflict Minerals Policy Statement

LasersCom LLC achieves business objectives and customer needs with social responsibility. We do not support or contribute to the violence and human rights violations associated with the mining of conflict minerals coming from Conflict Regions according to US "Dodd-Frank Act". When possible, our suppliers' conflict mineral statements are reviewed. We do not directly purchase Conflict Minerals from any source and do not knowingly procure any parts and products containing Conflict Minerals from Conflict Regions.

RoHS Compliance Statement

Restriction of Hazardous Substances (RoHS) directive (Directive 2011/65/EC amended with Directive (EU) 2015/863) is the directive aimed at reducing the harmful environmental impact of waste electrical equipment by restricting the use of known dangerous substances. Based on information received from our supply sources, LasersCom LLC hereby states that the banned substances listed in the RoHS directive are not found in the parts and materials used above the threshold level listed other than exceptions approved by the European Commission.

REACH Compliance Statement

Registration, Evaluation, Authorisation and Restriction of Chemicals (REACH) is a European Union regulation 1907/2006/EC that addresses the production and use of chemical substances, and their potential impacts on human health and the environment. Based on information received from our supply sources, LasersCom LLC hereby states compliance of the parts and materials used in manufacturing to REACH regulation. LasersCom LLC does not manufacture or import any substances or preparations as defined under REACH.